

2021 IEEE/SICE International Symposium on System Integration



SII 2021

IWAKI WASHINGTON HOTEL,
SPA RESORT HAWAIIANS

Iwaki, Fukushima, JAPAN

January 11-14, 2021

<https://sice-si.org/conf/SII2021/>

Call for Papers

IEEE/SICE SII is the premier symposium series presenting the state of the art and future perspectives of system integration, where industry experts, researchers, and academics share ideas and experiences surrounding frontier technologies, breakthrough and innovative solutions and applications.

The 2021 IEEE/SICE International Symposium on System Integration (SII 2021) will be as the 13th symposium on system integration. System integration is one of the key technologies and the integration of hardware and software is especially important to solve the industrial or social system problems in new century. This symposium focuses to the new research and industrial application of system integration, and discusses the approach method to improve effectiveness of system integration.

Full Papers

The working language of the conference is English. Authors would submit their papers electronically in PDF format. For the first submission, full papers can be 4-6 pages. For the final submission, full papers should be 4-6 camera-ready pages with an option to extend to 8 pages with an additional fee. All papers are peer reviewed. Accepted papers will be published in IEEE proceedings volume to be included in IEEE Xplore.

Workshops and Tutorials

Proposals for half-day or full-day workshops or tutorials list of prospective speakers should include: title, organizers, abstract, brief description of the area of interest, and a list of prospective speakers.

Interactive Sessions (Short Papers)

Interactive sessions provide a great opportunity for authors to present their early-stage research, late breaking results, prototypes and products to symposium attendees. We will provide a poster and demonstration area. Our goal is to provide a highly interactive forum for lively discussions and hands-on experiences. For the submission, papers should be 2 pages and be 2 camera-ready pages. All short papers are peer reviewed and accepted papers will be published in IEEE proceedings volume to be included in IEEE Xplore.

Special Sessions

Special sessions provide the opportunity to focus in detail on particular emerging topics, which are not reflected in the list of conference tracks or represent a specific working field where researchers would like to meet and discuss advances.

Topics

Topics of interest include but are not limited to

- **System integration**

Control technologies, Robotics, Network systems, Plant engineering, Integration platform, Software design, Hardware design

- **Artifacts**

Mechatronics systems, Automation, Virtual reality, Entertainment systems, Micro-nano systems.

- **Human and society**

Welfare systems, Human factors, Environment/Ecological systems, Bio systems, Rescue systems, Intelligent Transportation systems

- **Assistive Technologies**

Large-scale system simulation, Software systems, Networking systems, Decision making systems, Recognition, Human-robot interaction/ collaboration

Important Dates (tentative)

- **Proposals for Special sessions, workshops & Tutorials**

Submission deadline: July 15, 2020

Notification of acceptance: July 25, 2020

- **Full papers (4-6 pages)**

Submission deadline: August 1, 2020

Notification of acceptance: September 20, 2020

Final paper submission deadline: October 10, 2020

- **Interactive session – Short papers (2 pages)**

Submission deadline: September 30, 2020

Notification of acceptance: October 10, 2020

Conference Venue

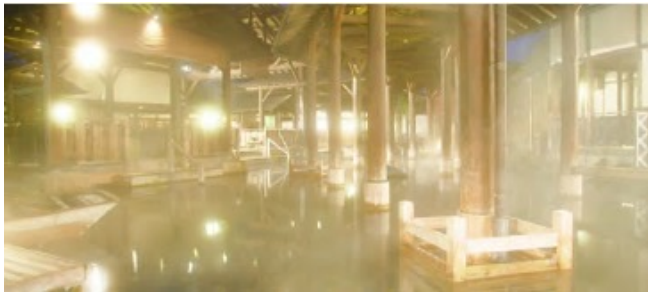
- **Technical sessions, workshops & Tutorials**

IWAKI WASHINGTON HOTEL



- **Plenary talk & Banquet**

SPA RESORT HAWAIIANS



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